



Title of Change:	Update to SOIC-8 Insourcing to ON Semiconductor Philippines (OSPI) Factory from HANA (Thailand) – Phase 1							
Proposed first ship date:	23 June 2018							
Contact information:	Contact your local ON Semiconductor Sales Office or <Scott.Brow@onsemi.com>							
Samples:	Contact your local ON Semiconductor Sales Office or <PCN.Samples@onsemi.com>							
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or <Kyungwon.Kang@onsemi.com>							
Type of notification:	This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days prior to implementation of the change. ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <PCN.Support@onsemi.com>.							
Change Part Identification:	Product marked with date code 1810 or later may be built from current factory or from OSPI Factory. The trace code marking on Line 2 is of the form AYW where A = Assembly Location, L = Wafer Lot ID and YW is a 2-digit date code. Product marked with "P" as the assembly location will be from OSPI. Additionally on the label of the box and reel, the ASSY LOC: PO will also indicate product assembled in OSPI. Please see sample label on Page 2 at the following URL http://www.onsemi.com/pub/Collateral/LABELRM-D.PDF to see the location of the ASSY LOC.							
Change category:	<input type="checkbox"/> Wafer Fab Change <input checked="" type="checkbox"/> Assembly Change <input checked="" type="checkbox"/> Test Change <input type="checkbox"/> Other _____							
Change Sub-Category(s):	<input checked="" type="checkbox"/> Manufacturing Site Change/Addition <input checked="" type="checkbox"/> Material Change <input type="checkbox"/> Datasheet/Product Doc change <input type="checkbox"/> Manufacturing Process Change <input type="checkbox"/> Product specific change <input checked="" type="checkbox"/> Shipping/Packaging/Marking <input type="checkbox"/> Other: _____							
Sites Affected:	ON Semiconductor Sites: ON Carmona, Philippines	External Foundry/Subcon Sites: HANA, Thailand						
Description and Purpose:								
This update notification is to correct (2) typos from FPCN22191X issued March 8, 2018. Page 2 identified the change in marking for all products affected by this change. The following products were listed incorrectly. The Line 1 marking for the products listed in this Update Notification are as listed:								
<table border="1"> <thead> <tr> <th>OPN</th> <th>Line 1 Marking</th> </tr> </thead> <tbody> <tr> <td>FAN7380MX_OP</td> <td>7380</td> </tr> <tr> <td>FAN7842MX</td> <td>7842</td> </tr> </tbody> </table>			OPN	Line 1 Marking	FAN7380MX_OP	7380	FAN7842MX	7842
OPN	Line 1 Marking							
FAN7380MX_OP	7380							
FAN7842MX	7842							
Reliability Data Summary:								
See original FPCN22191X								
Electrical Characteristic Summary:								
Electrical characteristics are not impacted by this change. Electrical comparison reports are available upon request								
List of Affected Standard Parts:								
Part Number		Qualification Vehicle						
FAN7380MX_OP		FAN7380MX						
FAN7842MX								



Appendix A: Changed Products

D

Product	Customer Part Number	Qualification Vehicle
FAN7380MX_OP		FAN7380MX
FAN7842MX		FAN7380MX